

HAT2165H

Silicon N Channel Power MOS FET Power Switching

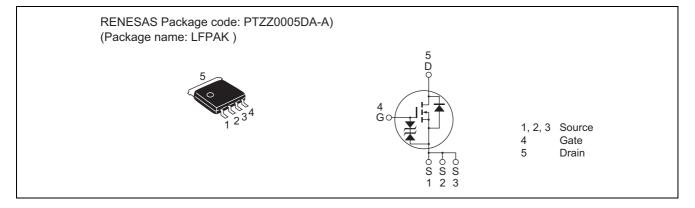
> REJ03G0004-0600 Rev.6.00 Sep 20, 2005

Features

- High speed switching
- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 2.5 \text{ m}\Omega \text{ typ.}$ (at $V_{GS} = 10 \text{ V}$)

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	55	A
Drain peak current	Note1 I _{D(pulse)}	220	A
Body-drain diode reverse drain current	I _{DR}	55	A
Avalanche current	I _{AP} Note 2	30	A
Avalanche energy	E _{AR} Note 2	90	mJ
Channel dissipation	Pch Note3	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25° C, Rg \geq 50 Ω

3. Tc = 25°C



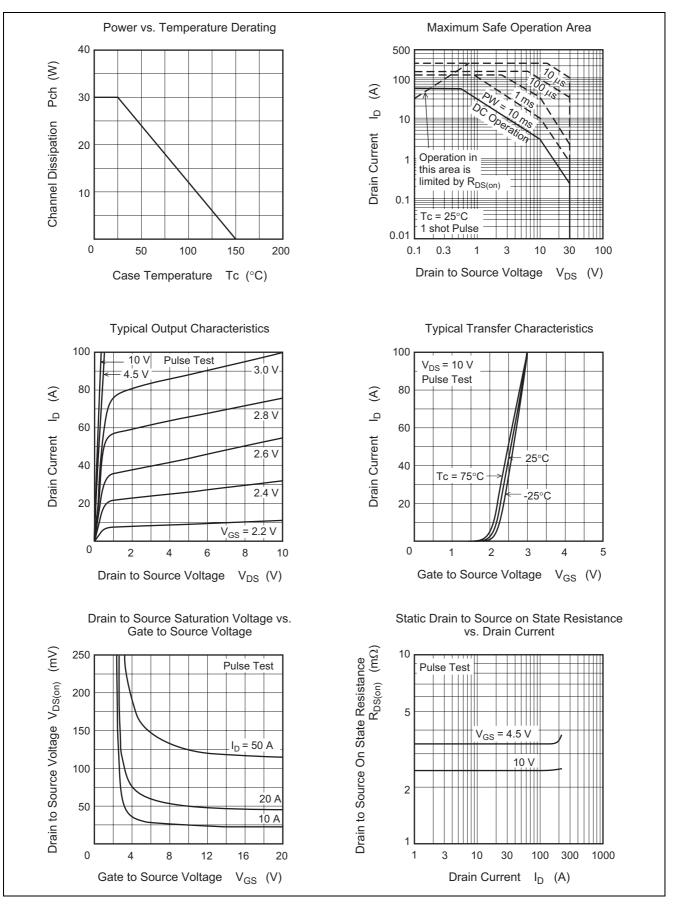
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	—	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_		±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	2.5	3.3	mΩ	$I_D = 27.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	3.4	5.3	mΩ	$I_D = 27.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	60	100	_	S	$I_D = 27.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	5180	_	pF	$V_{DS} = 10 V$, $V_{GS} = 0$, f = 1 MHz
Output capacitance	Coss	_	1200	_	pF	
Reverse transfer capacitance	Crss		380		pF	
Gate Resistance	Rg		0.5		Ω	
Total gate charge	Qg	_	33	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$ $I_D = 55 \text{ A}$
Gate to source charge	Qgs		15	_	nC	
Gate to drain charge	Qgd		7.1	_	nC	
Turn-on delay time	t _{d(on)}		13	_	ns	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \ V, \ I_D = 27.5 \ A, \\ V_{DD} \cong 10 \ V, \ R_L = 0.36 \ \Omega, \\ Rg = 4.7 \ \Omega \end{array}$
Rise time	tr		65	_	ns	
Turn-off delay time	t _{d(off)}		60	_	ns	
Fall time	t _f		9.5	_	ns	
Body–drain diode forward voltage	V _{DF}		0.81	1.06	V	$IF = 55 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t _{rr}		40	_	ns	$IF = 55 A, V_{GS} = 0$
time						di _F / dt = 100 A/ μs

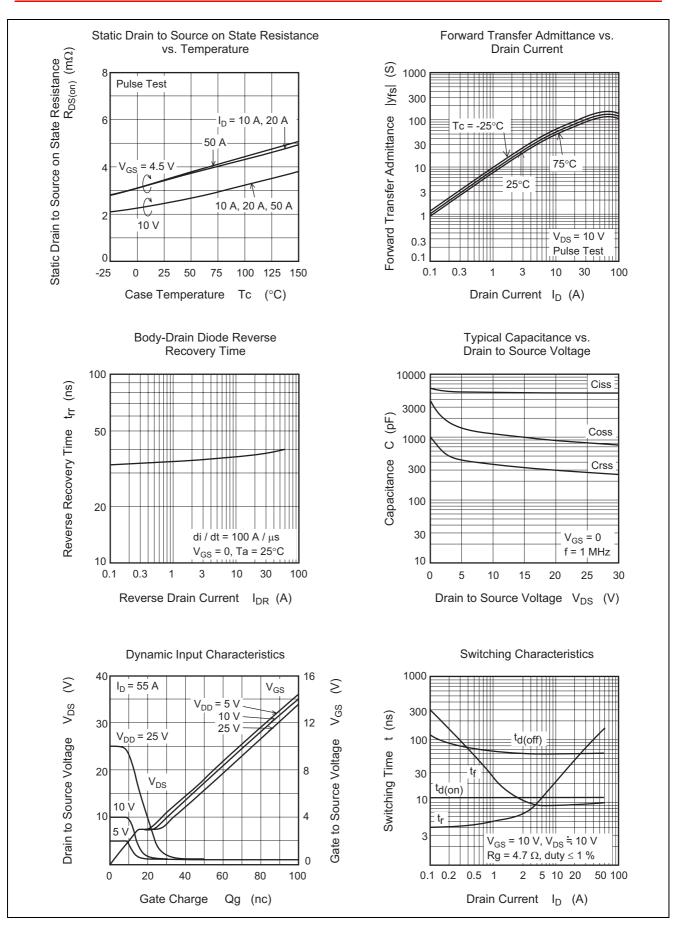
Notes: 4. Pulse test



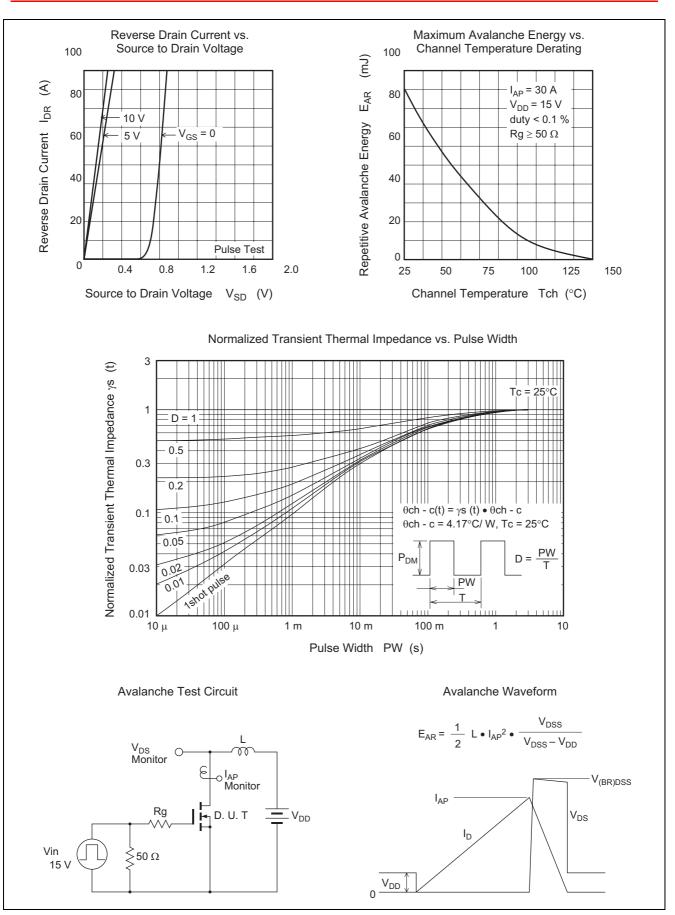
Main Characteristics



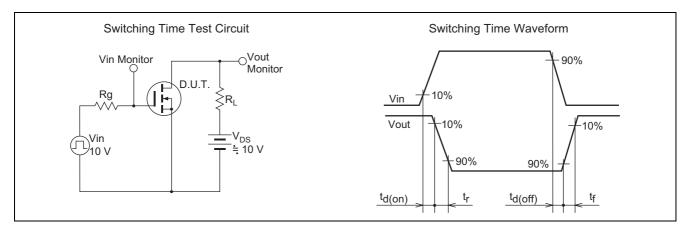






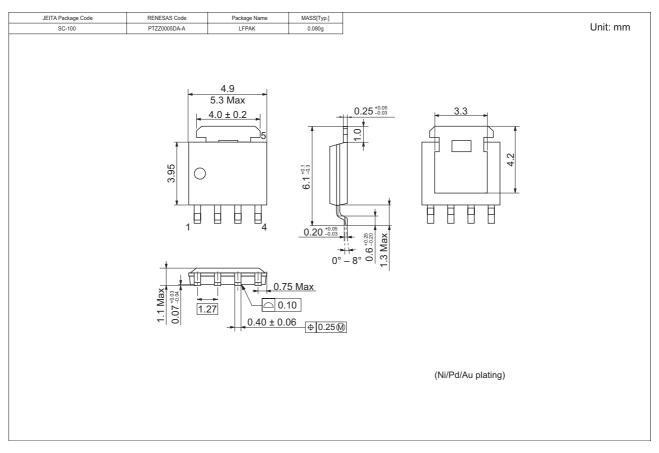








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2165H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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